

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ping LIU	05/24/2011
RECEIVING PARTY DATA	
Name:	GUANGDONG DONGBOND TECHNOLOGY CO., LTD
Street Address:	Songshanhu Scientific Industrial Park North C
City:	Dongguan, Guangdong
State/Country:	CHINA
Postal Code:	523808
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12137868
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	SHEN-43832
NAME OF SUBMITTER:	Paul A. Serbinowski
Total Attachments: 2 source=SHEN-43832-ExecutedAssign-PAS#page1.tif source=SHEN-43832-ExecutedAssign-PAS#page2.tif	

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PATENT
REEL: 026377 FRAME: 0444

ASSIGNMENT

WHEREAS, new and useful improvements have been made by the undersigned in

FUNCTIONAL MULTILAYER ANISOTROPIC CONDUCTIVE ADHESIVE FILM AND METHOD FOR PREPARING THE SAME

and are the subject of a patent application filed in the United States Patent and Trademark Office on June 12, 2008 as U.S. Ser. No. 12/137,868 which application is further identified as Pearne & Gordon LLP Docket No. SHEN-43832.

NOW, THEREFORE, be it known that, for valuable consideration, the receipt and sufficiency of which are hereby acknowledged, all of the undersigned's right, title, and interest, in the United States and throughout the world, in, to and under said improvements and inventions and all patents, patent applications, patent rights, and inventors' certificates thereof, therefor, and therein, including without limitation said undersigned's right, title and interest in: said application for patent in the United States; all divisions and continuations thereof; all patents which may be granted thereon; all reissues and extensions thereof; all right to sue for past infringement thereunder; all patents which may be granted for said improvements and inventions by states or nations other than the United States, or by other authority, entity, or organization, and all applications therefor, have been and are hereby sold, assigned, transferred, and delivered by the undersigned unto GUANGDONG DONGBOND TECHNOLOGY CO., LTD, having a principal place of business at Songshanhu Scientific Industrial Park North C, Dongguan, Guangdong 523808 (CN), hereinafter referred to as "assignee," its successors and assigns; and it is covenanted and agreed by the undersigned, and for executors, administrators, and legal representatives of the undersigned, that at assignee's request any and all applications, affidavits, assignments, and other instruments will be made, executed, and delivered as may be necessary, or desirable to secure for or vest in assignee, its successors or assigns, any improvement, inventions, right, title, interest, application, patent, patent right or other right or property covered by this assignment, and the United States Commissioner of Patents and Trademarks is hereby requested and authorized to issue any and all United States patents granted on any of said applications to assignee as owner of the entire right, title, and interest in, to, and under the same, and appropriately empowered officials of foreign countries are hereby authorized to issue any letters patent granted on any of said applications to assignee as owner of the entire right, title and interest in, to, and under the same.

The undersigned hereby grants the firm of Pearne & Gordon LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF, this assignment has been executed below by the undersigned:

1st Inventor:

Signature

2011. 5. 24.
Today's Date

Print Name: Ping LIU

Print Address: Danbang Technology Building, 1st Langshan Road, Northern Part, High Tech
Industry Zone, Shenzhen, Guangdong Province, 518052, China

Witness #1 Signature: _____

Witness #2 Signature: _____

Print Name: _____

Print Name: _____
